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2SD1527

Silicon NPN Triple Diffused

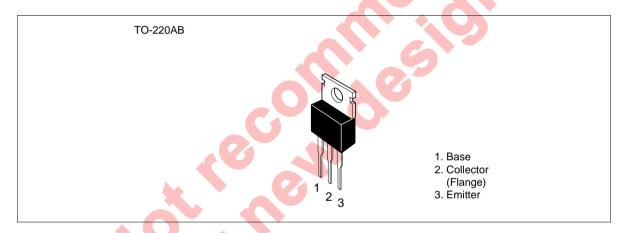


ADE-208-913 (Z) 1st. Edition September 2000

Application

High voltage power amplifier

Outline



Absolute Maximum Ratings (Ta = 25°C)

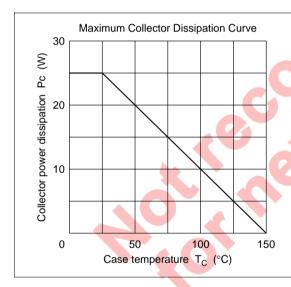
Item	Symbol	Rating	Unit
Collector to base voltage	V _{CBO}	1000	V
Collector to emitter voltage	V_{CEO}	1000	V
Emitter to base voltage	V _{EBO}	5	V
Collector current	I _c	0.5	A
Collector power dissipation	P _c	1.8	W
	P _c *1	25	W
Junction temperature	Тј	150	°C
Storage temperature	Tstg	-55 to +150	°C

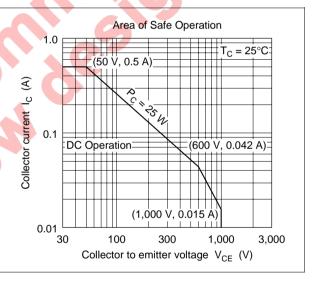
Note: 1. Value at $T_c = 25$ °C.

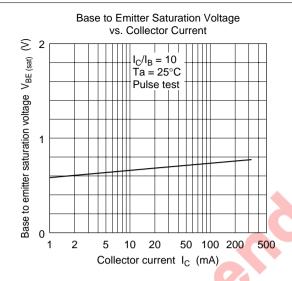
2SD1527

Electrical Characteristics (Ta = 25°C)

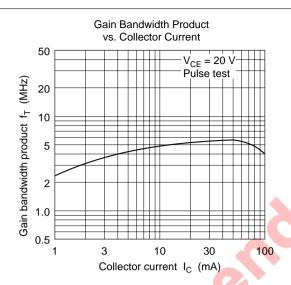
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	1000	_	_	V	I_{C} = 1 mA, R_{BE} = ∞
Emitter to base breakdown voltage	$V_{(BR)EBO}$	5	_	_	V	$I_{E} = 1 \text{ mA}, I_{C} = 0$
Collector cutoff current	I _{CBO}	_	_	10	μΑ	$V_{CB} = 800 \text{ V}, I_{E} = 0$
DC current transfer ratio	h _{FE1}	10	_	_		$V_{CE} = 5 \text{ V}, I_{C} = 10 \text{ mA}$
	h _{FE2}	10	_	_		$V_{CE} = 5 \text{ V}, I_{C} = 100 \text{ mA}$
Base to emitter voltage	V_{BE}	_	_	1.2	V	$V_{CE} = 5 \text{ V}, I_{C} = 100 \text{ mA}$
Collector to emitter saturation voltage	$V_{\text{CE (sat)}}$	_	-	5	V	$I_{\rm C} = 300 \text{ mA}, I_{\rm B} = 60 \text{ mA}$
Gain bandwidth product	f _T	_	5	_	MHz	$V_{CE} = 20 \text{ V}, I_{C} = 50 \text{ mA}$
Collector output capacitance	Cob	_	5	_	pF	$V_{CB} = 100 \text{ V}, I_{E} = 0, f = 1 \text{ MHz}$

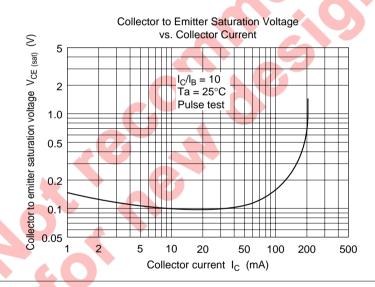


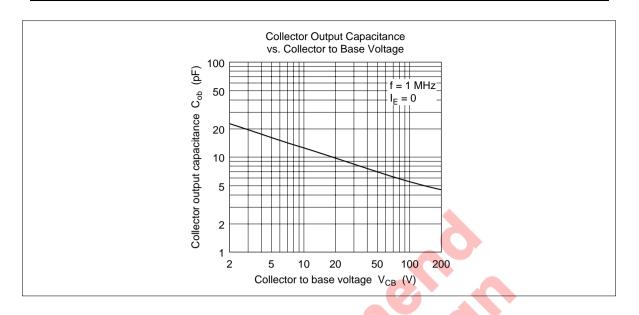












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HITACHI

Hitachi, Ltd.

Semiconductor & IC Div. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100, Japan Tel: Tokyo (03) 3270-2111

Fax: (03) 3270-5109

For further information write to:

Hitachi America, Ltd. Semiconductor & IC Div. 2000 Sierra Point Parkway Brisbane, CA. 94005-1835 U S A

Tel: 415-589-8300 Fax: 415-583-4207 Hitachi Europe GmbH Electronic Components Group Continental Europe Dornacher Straße 3 D-85622 Feldkirchen München

Tel: 089-9 91 80-0 Fax: 089-9 29 30 00 Hitachi Europe Ltd.
Electronic Components Div.
Northern Europe Headquarters
Whitebrook Park
Lower Cookham Road
Maidenhead
Berkshire SL6 8YA

United Kingdom Tel: 0628-585000 Fax: 0628-778322 Hitachi Asia Pte. Ltd. 16 Collyer Quay #20-00 Hitachi Tower Singapore 0104 Tel: 535-2100 Fax: 535-1533

Hitachi Asia (Hong Kong) Ltd. Unit 706, North Tower, World Finance Centre, Harbour City, Canton Road Tsim Sha Tsui, Kowloon Hong Kong

Tel: 27359218 Fax: 27306071

